IPC ASSOCIATION ELECTRONIC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved unde international and Pan-American copyright conventions.		T le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1					Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
Supplier	r Information						·								
Company name* Company				y unique ID			Unique ID Authority					Response Date*			
nsemi												2024-05-16			
Contact N	ame	Title - Contact			F	Phone - Contact*					Email - Contact*				
Product-I	Env-Stewards		Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com			
uthorize	d Representative*	Title - Representative			F	Phone - Representative*				Email - Representative*					
Product-I	Env-Stewards	Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	ive Date Version Manufacturing Site		ing Site	W	eight*	UOM	Unit Type	
		74AC86	74AC86SCX FACT QUA		UAD 2-INPUT XOR		2024-05-16 PH		PH1		15	53.57	mg	Each	
Ianufa	cturing Proccess Informa	ation													
	Terminal Plating / Grid Array M	inal Plating / Grid Array Material		Terminal Base Alloy J-STD-02		Rating	Peak Process Body Temperatur		e Max Ti	ne at Peak T	Гетрегаtu	re Numb	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed		CU Alloy 1				260	C		30		seconds 3				
omments															
<u>vel 1 - m</u>	aximum time at peak temperat	ture during sol	dering is 10-3	30 seconds											
or more i	information regarding materia	l composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.222	mg	Supplier	Silicon (Si)	7440-21-3		0.222	mg
Die Attach	0.09	mg		Epoxy resin	proprietary data		0.009	mg
			Supplier	Silver (Ag)	7440-22-4		0.072	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.009	mg
Lead Frame	68.01	mg	Supplier	Zinc (Zn)	7440-66-6		0.0816	mg
			Supplier	Iron (Fe)	7439-89-6		1.5982	mg
			Supplier	Copper (Cu)	7440-50-8		66.3098	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0204	mg
Lead Frame plating	0.7	mg	Supplier	Silver (Ag)	7440-22-4		0.7	mg
Mold Compound-Black	81.971	mg		Epoxy resin	proprietary data		4.0986	mg
			Supplier	Phenolic Resin	Proprietary Data		1.6394	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.0493	mg
			Supplier	Carbon Black (C)	1333-86-4		0.4099	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		73.7739	mg
Plating	2.514	mg	Supplier	Tin (Sn)	7440-31-5		2.514	mg
Wire Bond - Au	0.063	mg	Supplier	Gold (Au)	7440-57-5		0.063	mg